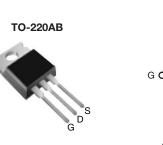


Vishay Siliconix

Power MOSFET

| PRODUCT SUMMARY | | | | | |
|----------------------------|-----------------------------|--|--|--|--|
| V _{DS} (V) | 200 | | | | |
| R _{DS(on)} (Ω) | V _{GS} = 10 V 0.80 | | | | |
| Q _g (Max.) (nC) | 14 | | | | |
| Q _{gs} (nC) | 3.0 | | | | |
| Q _{gd} (nC) | 7.9 | | | | |
| Configuration | Single | | | | |



S N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION | |
|----------------------|------------|
| Package | TO-220AB |
| Lead (Pb)-free | IRF620PbF |
| Lead (Fb)-liee | SiHF620-E3 |
| SnPb | IRF620 |
| | SiHF620 |

| ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \text{ °C}$, unless otherwise noted) | | | | | |
|-----------------------------------------------------------------------------------|-------------------------|------------------------|-----------------------------------|------------------|----------|
| PARAMETER | | | SYMBOL | LIMIT | UNIT |
| Drain-Source Voltage | | | V _{DS} | 200 | V |
| Gate-Source Voltage | | | V _{GS} | ± 20 | v |
| Continuous Drain Current | V at 10 V | T _C = 25 °C | | 5.2 | |
| Continuous Drain Current | V _{GS} at 10 V | $T_C = 100 \ ^\circ C$ | I _D | 3.3 | А |
| Pulsed Drain Current ^a | | | I _{DM} | 18 | |
| Linear Derating Factor | | | | 0.40 | W/°C |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 110 | mJ |
| Repetitive Avalanche Current ^a | | | I _{AR} | 5.2 | A |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 5.0 | mJ |
| Maximum Power Dissipation $T_{C} = 25 \text{ °C}$ | | | PD | 50 | W |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 5.0 | V/ns |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 150 | °C |
| Soldering Recommendations (Peak Temperature) for 10 s | | | | 300 ^d | U |
| Mounting Torque | 6 32 or 1 | 6-32 or M3 screw | | 10 | lbf ∙ in |
| | 0-32 OF IVI3 SCIEW | | | 1.1 | N·m |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 6.1 mH, $R_g = 25 \Omega$, $I_{AS} = 5.2 \text{ A}$ (see fig. 12).

c. $I_{SD} \le 5.2$ A, dI/dt ≤ 95 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91027 S11-0510-Rev. B, 21-Mar-11 www.vishay.com

Vishay Siliconix



| THERMAL RESISTANCE RATINGS | | | | |
|-------------------------------------|-------------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient | R _{thJA} | - | 62 | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.50 | - | °C/W |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 2.5 | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------------|-----------------------|------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------|------|------|------------|------|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} : | = 0 V, I _D = 250 μΑ | 200 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | e to 25 °C, I _D = 1 mA | - | 0.29 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μΑ | 2.0 | - | 4.0 | V |
| Gate-Source Leakage | I _{GSS} | | V _{GS} = ± 20 V | - | - | ± 100 | nA |
| Zero Gate Voltage Drain Current | Inne | V _{DS} = | = 200 V, V _{GS} = 0 V | - | - | 25 | μA |
| Zero Gale Voltage Drain Gurrent | IDSS | V _{DS} = 160 \ | ∕, V _{GS} = 0 V, T _J = 125 °C | - | - | 250 | |
| Drain-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 10 V$ | I _D = 3.1 A ^b | - | - | 0.80 | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} | = 50 V, I _D = 3.1 A | 1.5 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | | $V_{GS} = 0 V$, | - | 260 | - | pF |
| Output Capacitance | Coss | | $V_{DS} = 25 V,$ | - | 100 | - | |
| Reverse Transfer Capacitance | C _{rss} | f = 1 | .0 MHz, see fig. 5 | - | 30 | - | |
| Total Gate Charge | Qg | | | - | - | 14 | nC |
| Gate-Source Charge | Q _{gs} | V _{GS} = 10 V | $I_D = 4.8 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and 13^{b} | - | - | 3.0 | |
| Gate-Drain Charge | Q _{gd} | | see lig. 6 and 15 | - | - | 7.9 | |
| Turn-On Delay Time | t _{d(on)} | $V_{DD} = 100 \text{ V}, \text{ I}_D = 4.8 \text{ A},$ $\text{R}_g = 18 \ \Omega, \ \text{R}_D = 20 \ \Omega, \text{ see fig. } 10^{\text{b}}$ | | - | 7.2 | - | - ns |
| Rise Time | t _r | | | - | 22 | - | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 19 | - | |
| Fall Time | t _f | | | - | 13 | - | |
| Internal Drain Inductance | L _D | Between lead, 6 mm (0.25") from | | - | 4.5 | - | |
| Internal Source Inductance | L _S | package and center of die contact | | - | 7.5 | - | nH |
| Drain-Source Body Diode Characteristic | S | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 5.2 | _ |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 18 | A |
| Body Diode Voltage | V_{SD} | T_J = 25 °C, I_S = 5.2 A, V_{GS} = 0 V ^b | | - | - | 1.8 | V |
| Body Diode Reverse Recovery Time | t _{rr} | $T_J = 25 \text{ °C}, I_F = 4.8 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}$ | | - | 150 | 300 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 0.91 | 1.8 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D) | | | | <u>ו ה</u> | |

Notes

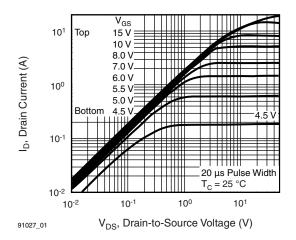
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

www.vishay.com 2 Document Number: 91027 S11-0510-Rev. B, 21-Mar-11



Vishay Siliconix



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



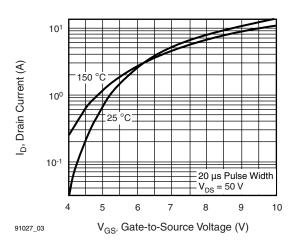


Fig. 3 - Typical Transfer Characteristics

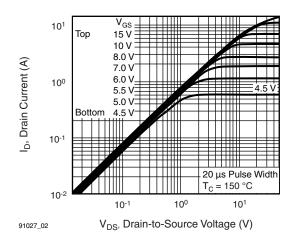


Fig. 2 - Typical Output Characteristics, T_C = 150 $^\circ C$

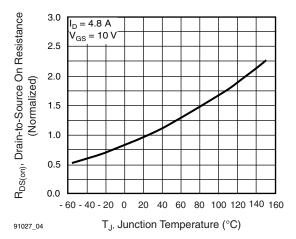


Fig. 4 - Normalized On-Resistance vs. Temperature

Document Number: 91027 S11-0510-Rev. B, 21-Mar-11 www.vishay.com

Vishay Siliconix



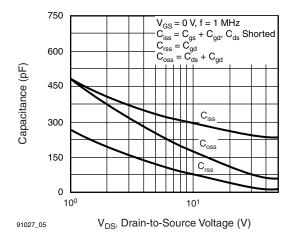


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

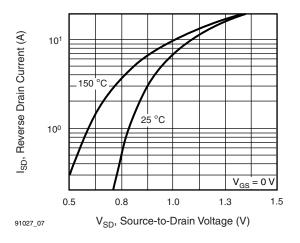


Fig. 7 - Typical Source-Drain Diode Forward Voltage

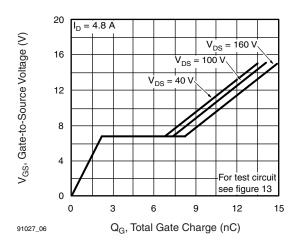


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

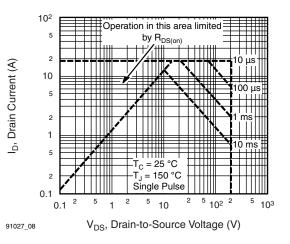


Fig. 8 - Maximum Safe Operating Area

Document Number: 91027 S11-0510-Rev. B, 21-Mar-11



Vishay Siliconix

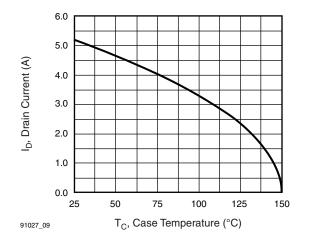


Fig. 9 - Maximum Drain Current vs. Case Temperature

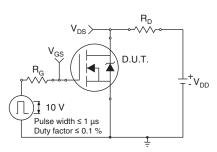


Fig. 10a - Switching Time Test Circuit

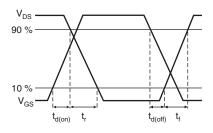
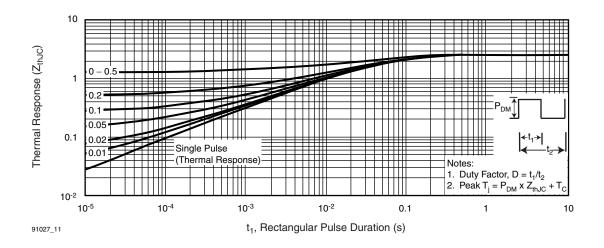
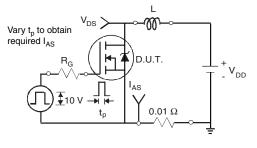
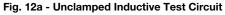


Fig. 10b - Switching Time Waveforms









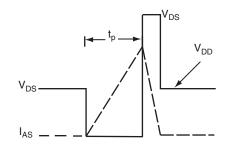
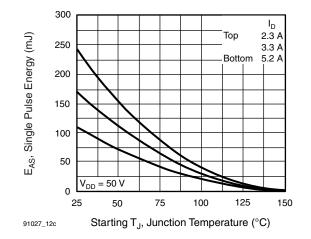


Fig. 12b - Unclamped Inductive Waveforms

Document Number: 91027 S11-0510-Rev. B, 21-Mar-11

Vishay Siliconix







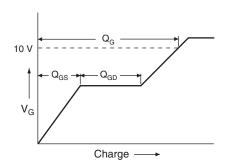


Fig. 13a - Basic Gate Charge Waveform

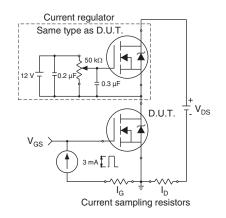
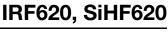


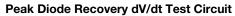
Fig. 13b - Gate Charge Test Circuit

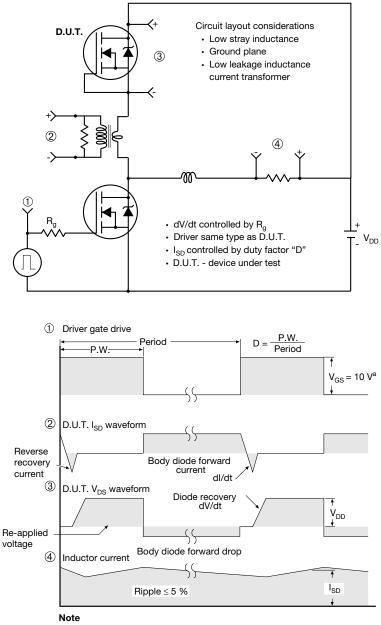
www.vishay.com 6 Document Number: 91027 S11-0510-Rev. B, 21-Mar-11



Vishay Siliconix







a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?91027.

Document Number: 91027 S11-0510-Rev. B, 21-Mar-11 www.vishay.com



www.vishay.com

TO-220-1



| DIM. | MILLIN | MILLIMETERS | | INCHES | | |
|----------------------------------------------|--------|-------------|-------|--------|--|--|
| DIN. | MIN. | MAX. | MIN. | MAX. | | |
| А | 4.24 | 4.65 | 0.167 | 0.183 | | |
| b | 0.69 | 1.02 | 0.027 | 0.040 | | |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 | | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | | |
| D | 14.33 | 15.85 | 0.564 | 0.624 | | |
| E | 9.96 | 10.52 | 0.392 | 0.414 | | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | | |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 | | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | | |
| L | 13.36 | 14.40 | 0.526 | 0.567 | | |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 | | |
| ØР | 3.53 | 3.94 | 0.139 | 0.155 | | |
| Q | 2.54 | 3.00 | 0.100 | 0.118 | | |
| ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031 | | | | | | |

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

| Package Picture | | | | |
|-----------------|--|---------------------|-----|--|
| ASE | | Xi | 'an | |
| | | IRF 9510 744K AB | | |

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay: IRF620 IRF620PBF